



## Description

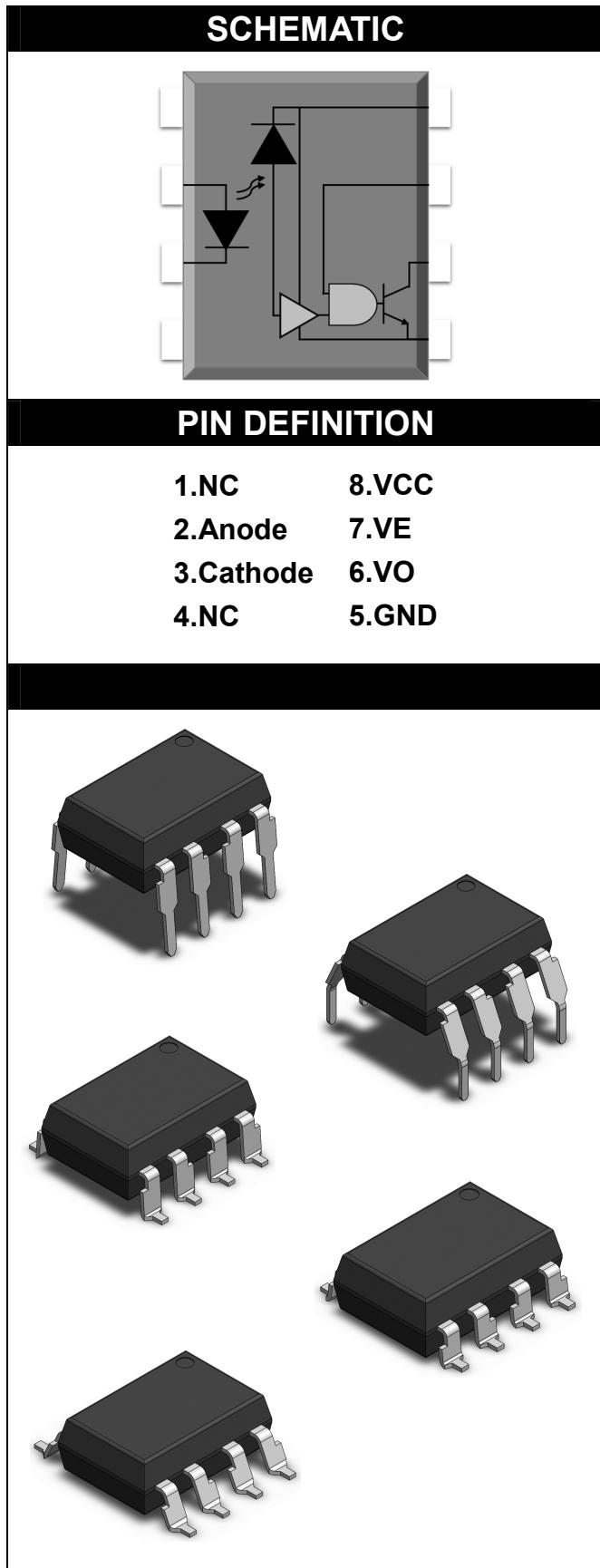
The 6N137, TD2601, TD2611 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon high speed integrated photo-detector logic gate with a strobable output in a plastic DIP8 package with different lead forming options.

## Features

- High isolation 5000 VRMS
- DC input with logic gate output
- Operating temperature range - 55 °C to 100 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals (Pending Approved)
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC – GB4943.1, GB8898

## Applications

- Ground loop elimination
- LSTTL to TTL, LSTTL or CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supply
- Pulse transformer replacement
- Computer-peripheral interface





| ABSOLUTE MAXIMUM RATINGS |                       |         |                  |      |
|--------------------------|-----------------------|---------|------------------|------|
| PARAMETER                | SYMBOL                | VALUE   | UNIT             | Note |
| INPUT                    |                       |         |                  |      |
| Forward Current          | I <sub>F</sub>        | 25      | mA               |      |
| Peak Forward Current     | I <sub>FP</sub>       | 50      | mA               | 1    |
| Peak Transient Current   | I <sub>F(trans)</sub> | 1       | A                | 2    |
| Reverse Voltage          | V <sub>R</sub>        | 5       | V                |      |
| Enable Voltage           | V <sub>E</sub>        | VCC+0.5 | V                |      |
| Input Power Dissipation  | P <sub>I</sub>        | 100     | mW               |      |
| OUTPUT                   |                       |         |                  |      |
| Supply Voltage           | V <sub>CC</sub>       | 7       | V                |      |
| Output Voltage           | V <sub>O</sub>        | 7       | V                |      |
| Output Current           | I <sub>O</sub>        | 50      | mA               |      |
| Output Power Dissipation | P <sub>O</sub>        | 85      | mW               |      |
| COMMON                   |                       |         |                  |      |
| Total Power Dissipation  | P <sub>tot</sub>      | 200     | mW               |      |
| Isolation Voltage        | V <sub>iso</sub>      | 5000    | V <sub>rms</sub> | 3    |
| Operating Temperature    | T <sub>opr</sub>      | -55~100 | °C               |      |
| Storage Temperature      | T <sub>stg</sub>      | -55~125 | °C               |      |
| Soldering Temperature    | T <sub>sol</sub>      | 260     | °C               | 4    |

Note 1. 50% duty, 1ms P.W

Note 2. ≤1μs P.W,300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds



| RECOMMENDED OPERATION CONDITIONS |  |        |  |      |      |
|----------------------------------|--|--------|--|------|------|
| PARAMETER                        |  | SYMBOL |  | MIN. | MAX. |
| Operating Temperature            |  | TA     |  | -40  | 100  |
| Supply Voltage                   |  | VCC    |  | 2.7  | 3.6  |
|                                  |  | VCC    |  | 4.5  | 5.5  |
| Low Level Input Current          |  | IFL    |  | 0    | 250  |
| High Level Input Current         |  | IFH    |  | 5    | 15   |
| Low Level Enable Voltage         |  | VEL    |  | 0    | 0.8  |
| High Level Enable Voltage        |  | VEH    |  | 2    | VCC  |
| Output Pull-up Resistor          |  | RL     |  | 330  | 4k   |
| Fan Out (at RL=1kΩ per channel)  |  | N      |  | -    | 5    |
| TTL Loads                        |  |        |  |      |      |

| ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C |                  |                  |                  |      |      |   |
|---|------------------|------------------|------------------|------|------|---|
| PARAMETER                                     | SYMBOL           | MIN.             | TYP.             | MAX. | UNIT | TEST CONDITION  |
| INPUT   |                  |                  |                  |      |      |   |
| Forward Voltage                               | V <sub>F</sub>   | -                | 1.38             | 1.8  | V    | I <sub>F</sub> =10mA  |
| Reverse Current                               | I <sub>R</sub>   | -                | -                | 10   | µA   | V <sub>R</sub> =5V  |
| Input Capacitance                             | C <sub>in</sub>  | -                | 13               | -    | pF   | V=0, f=1MHz   |
| OUTPUT  |                  |                  |                  |      |      |   |
| High Level Supply Current                     | I <sub>CCH</sub> | -                | 6.3              | 10   | mA   | I <sub>F</sub> =0mA, V <sub>E</sub> =0.5V, V <sub>CC</sub> =5.5V                            |
| Low Level Supply Current                      | I <sub>CCL</sub> | -                | 8.3              | 13   | mA   | I <sub>F</sub> =10mA, V <sub>CC</sub> =5.5V   |
| High Level Enable Current                     | I <sub>EH</sub>  | -                | -0.52            | -1.6 | mA   | V <sub>E</sub> =2.0V, V <sub>CC</sub> =5.5V   |
| Low Level Enable Current                      | I <sub>EL</sub>  | -                | -0.75            | -1.6 | mA   | V <sub>E</sub> =0.5V, V <sub>CC</sub> =5.5V   |
| High Level Enable Voltage                     | V <sub>EH</sub>  | 2.0              | -                | -    | V    | I <sub>F</sub> =10mA, V <sub>CC</sub> =5.5V   |
| Low Level Enable Voltage                      | V <sub>EL</sub>  | -                | -                | 0.8  | V    | I <sub>F</sub> =10mA, V <sub>CC</sub> =5.5V   |
| TRANSFER CHARACTERISTICS (Ta=-40 to 85°C)     |                  |                  |                  |      |      |   |
| High Level Output Current                     | I <sub>OH</sub>  | -                | 0.73             | 100  | µA   | V <sub>CC</sub> =5.5V, V <sub>O</sub> =5.5V,<br>I <sub>F</sub> =250µA, V <sub>E</sub> =2.0V |
| Low Level Output Voltage                      | V <sub>OL</sub>  | -                | 0.28             | 0.6  | V    | V <sub>CC</sub> =5.5V, I <sub>F</sub> =5mA,<br>V <sub>E</sub> =2.0V, I <sub>CL</sub> =13mA  |
| Input Threshold Current                       | I <sub>IT</sub>  | -                | 2.5              | 5    | mA   | V <sub>CC</sub> =5.5V, V <sub>O</sub> =0.6V,<br>V <sub>E</sub> =2.0V, I <sub>OL</sub> =13mA |
| Isolation Resistance                          | R <sub>iso</sub> | 10 <sup>12</sup> | 10 <sup>14</sup> | -    | Ω    | DC500V, 40 ~ 60% R.H.   |
| Floating Capacitance                          | C <sub>IO</sub>  | -                | 1.0              | -    | pF   | V=0, f=1MHz   |



| ELECTRICAL OPTICAL CHARACTERISTICS  |           |      |       |  |      |  |      |
|---|-----------|------|-------|--|------|--|------|
| PARAMETER   | SYMBOL    | MIN. | TYP.  | MAX.   | UNIT | TEST CONDITION   | NOTE |
| SWITCHING CHARACTERISTICS (Ta=-40 to 85°C, V <sub>CC</sub> =5V, I <sub>F</sub> =7.5mA unless specified otherwise) |           |      |       |  |      |  |      |
| Propagation Delay Time to Output Low Level  | TPHL      | -    | 35    | 75   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω, Ta=25°C  |      |
| Propagation Delay Time to Output High Level   | TPLH      | -    | 40    | 75   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω, Ta=25°C  |      |
| Pulse Width Distortion  | TPHL-TPLH | -    | 5     | 35   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω   |      |
| Rise Time   | tr        | -    | 27    | -  | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω   |      |
| Fall Time   | tf        | -    | 7     | -  | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω   |      |
| Enable Propagation Delay Time to Output Low Level   | TEHL      | -    | 15    | -  | ns   | I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.5V, C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω                 |      |
| Enable Propagation Delay Time to Output High Level  | TELH      | -    | 15    | -  | ns   | I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.5V, C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω                 |      |
| Common Mode Transient Immunity at Logic High  | 6N137     | CMH  | -     | -  | -    | I <sub>F</sub> = 7.5mA , V <sub>OH</sub> =2.0V, R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =10Vp-p |      |
|   | TD2601    |      | 5000  | -  | -    |  |      |
|   | TD2611    |      | 10000 | -  | -    |  |      |
| Common Mode Transient Immunity at Logic Low   | 6N137     | CML  | -     | -  | -    | I <sub>F</sub> = 7.5mA , V <sub>OH</sub> =2.0V, R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =50Vp-p |      |
|   | TD2601    |      | 5000  | -  | -    |  |      |
|   | TD2611    |      | 10000 | -  | -    |  |      |
|   |           |      | V/μs  | I <sub>F</sub> = 0mA , V <sub>OH</sub> =0.8V, R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =10Vp-p |      |  |      |
|   |           |      |       |  |      |  |      |
|   |           |      |       |  |      |  |      |



| ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C |                  |                  |                  |      |      |  |
|---|------------------|------------------|------------------|------|------|--|
| PARAMETER                                     | SYMBOL           | MIN.             | TYP.             | MAX. | UNIT | TEST CONDITION   |
| INPUT   |                  |                  |                  |      |      |  |
| Forward Voltage                               | V <sub>F</sub>   | -                | 1.38             | 1.8  | V    | I <sub>F</sub> =10mA   |
| Reverse Current                               | I <sub>R</sub>   | -                | -                | 10   | μA   | V <sub>R</sub> =5V   |
| Input Capacitance                             | C <sub>in</sub>  | -                | 13               | -    | pF   | V=0, f=1MHz  |
| OUTPUT  |                  |                  |                  |      |      |  |
| High Level Supply Current                     | I <sub>CCH</sub> | -                | 4.3              | 10   | mA   | I <sub>F</sub> =0mA, V <sub>E</sub> =0.5V, V <sub>CC</sub> =3.3V                         |
| Low Level Supply Current                      | I <sub>CCL</sub> | -                | 6.4              | 13   | mA   | I <sub>F</sub> =10mA, V <sub>CC</sub> =3.3V  |
| High Level Enable Current                     | I <sub>EH</sub>  | -                | -0.21            | -1.6 | mA   | V <sub>E</sub> =2.0V, V <sub>CC</sub> =3.3V  |
| Low Level Enable Current                      | I <sub>EL</sub>  | -                | -0.42            | -1.6 | mA   | V <sub>E</sub> =0.5V, V <sub>CC</sub> =3.3V  |
| High Level Enable Voltage                     | V <sub>EH</sub>  | 2.0              | -                | -    | V    | I <sub>F</sub> =10mA, V <sub>CC</sub> =3.3V  |
| Low Level Enable Voltage                      | V <sub>EL</sub>  | -                | -                | 0.8  | V    | I <sub>F</sub> =10mA, V <sub>CC</sub> =3.3V  |
| TRANSFER CHARACTERISTICS (Ta=-40 to 85°C)     |                  |                  |                  |      |      |  |
| High Level Output Current                     | I <sub>OH</sub>  | -                | 4.1              | 100  | μA   | V <sub>CC</sub> =3.3V, V <sub>O</sub> =3.3V, I <sub>F</sub> =250μA, V <sub>E</sub> =2.0V |
| Low Level Output Voltage                      | V <sub>OL</sub>  | -                | 0.29             | 0.6  | V    | V <sub>CC</sub> =3.3V, I <sub>F</sub> =5mA, V <sub>E</sub> =2.0V, I <sub>CL</sub> =13mA  |
| Input Threshold Current                       | I <sub>FT</sub>  | -                | 2.2              | 5    | mA   | V <sub>CC</sub> =3.3V, V <sub>O</sub> =0.6V, V <sub>E</sub> =2.0V, I <sub>OL</sub> =13mA |
| Isolation Resistance                          | R <sub>iso</sub> | 10 <sup>12</sup> | 10 <sup>14</sup> | -    | Ω    | DC500V, 40 ~ 60% R.H.  |
| Floating Capacitance                          | C <sub>IO</sub>  | -                | 1.0              | -    | pF   | V=0, f=1MHz  |

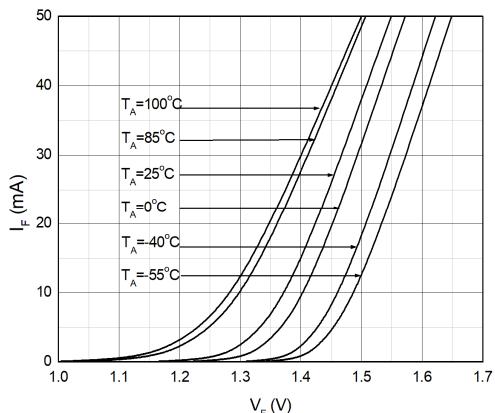


| ELECTRICAL OPTICAL CHARACTERISTICS  |           |      |       |      |      |   |  |
|---|-----------|------|-------|------|------|---|--|
| PARAMETER   | SYMBOL    | MIN. | TYP.  | MAX. | UNIT | TEST CONDITION  | NOTE   |
| SWITCHING CHARACTERISTICS (Ta=-40 to 85°C, V <sub>CC</sub> =3.3V, I <sub>F</sub> =7.5mA unless specified otherwise) |           |      |       |      |      |   |  |
| Propagation Delay Time to Output Low Level  | TPHL      | -    | 35    | 75   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω, Ta=25°C   |  |
| Propagation Delay Time to Output High Level   | TPLH      | -    | 47    | 75   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω, Ta=25°C   |  |
| Pulse Width Distortion  | TPHL-TPLH | -    | 12    | 35   | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω  |  |
| Rise Time   | tr        | -    | 30    | -    | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω  |  |
| Fall Time   | tf        | -    | 8.5   | -    | ns   | C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω  |  |
| Enable Propagation Delay Time to Output Low Level   | TEHL      | -    | 15    | -    | ns   | I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.3V,<br>C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω |  |
| Enable Propagation Delay Time to Output High Level  | TELH      | -    | 15    | -    | ns   | I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.3V,<br>C <sub>L</sub> =15pF, R <sub>L</sub> =350Ω |  |
| Common Mode Transient Immunity at Logic High  | 6N137     | CMH  | -     | -    | -    | V/μs  | I <sub>F</sub> = 7.5mA , V <sub>OH</sub> =2.0V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =10Vp-p  |
|   | TD2601    |      | 5000  | -    | -    |   | I <sub>F</sub> = 7.5mA , V <sub>OH</sub> =2.0V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =50Vp-p  |
|   | TD2611    |      | 10000 | -    | -    |   | I <sub>F</sub> = 7.5mA , V <sub>OH</sub> =2.0V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =400Vp-p |
| Common Mode Transient Immunity at Logic Low   | 6N137     | CML  | -     | -    | -    | V/μs  | I <sub>F</sub> = 0mA , V <sub>OH</sub> =0.8V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =10Vp-p    |
|   | TD2601    |      | 5000  | -    | -    |   | I <sub>F</sub> = 0mA , V <sub>OH</sub> =0.8V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =50Vp-p    |
|   | TD2611    |      | 10000 | -    | -    |   | I <sub>F</sub> = 0mA , V <sub>OH</sub> =0.8V,<br>R <sub>L</sub> =350Ω, Ta=25°C<br>V <sub>CM</sub> =400Vp-p   |

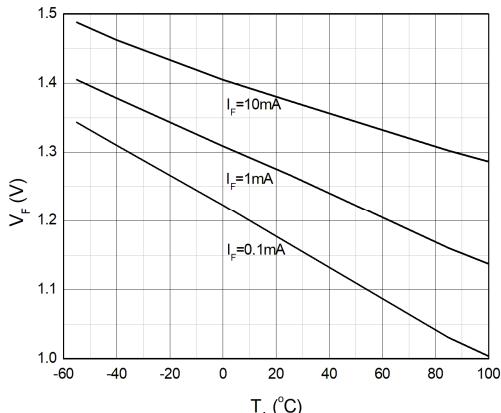


### CHARACTERISTIC CURVES

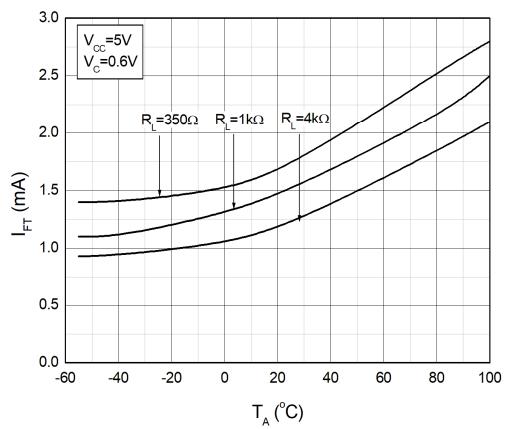
**Fig.1 Forward Current  
vs. Forward Voltage**



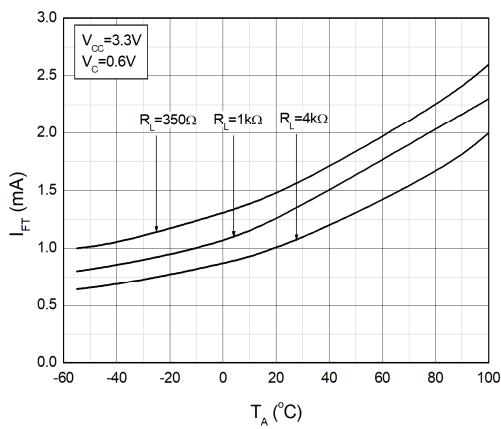
**Fig.2 Forward Voltage  
vs. Ambient Temperature**



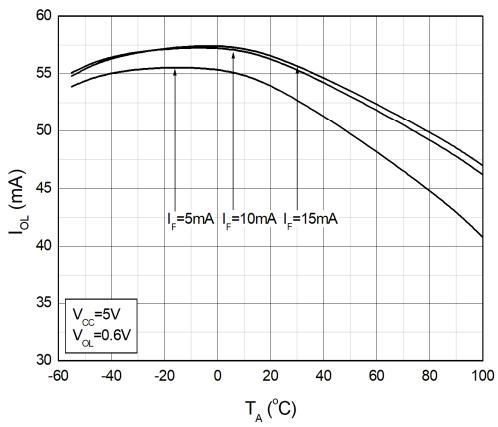
**Fig.3 Input Threshold Current  
vs. Ambient Temperature**



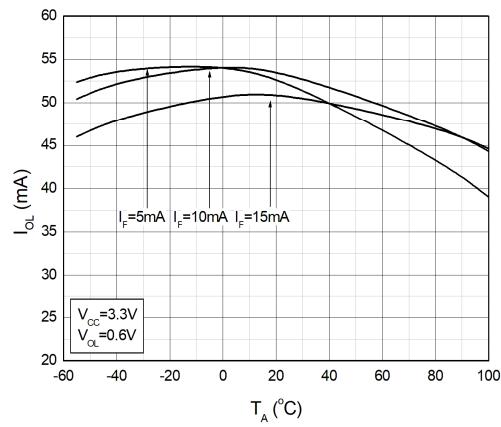
**Fig.4 Input Threshold Current  
vs. Ambient Temperature**



**Fig.5 Low Level Output Current  
vs. Ambient Temperature**



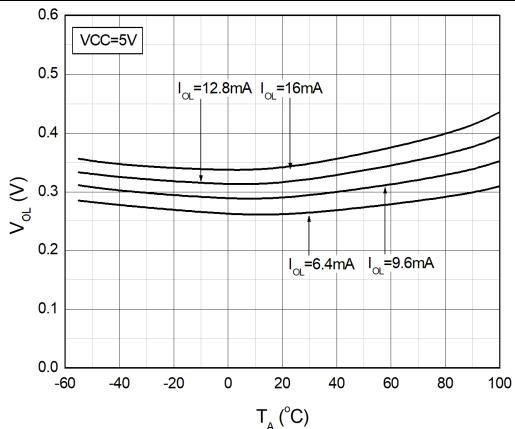
**Fig.6 Low Level Output Current  
vs. Ambient Temperature**



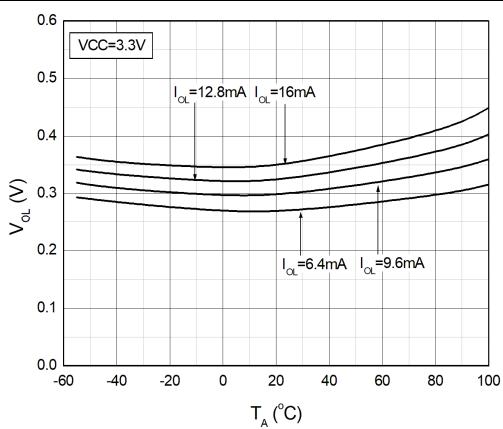


### CHARACTERISTIC CURVES

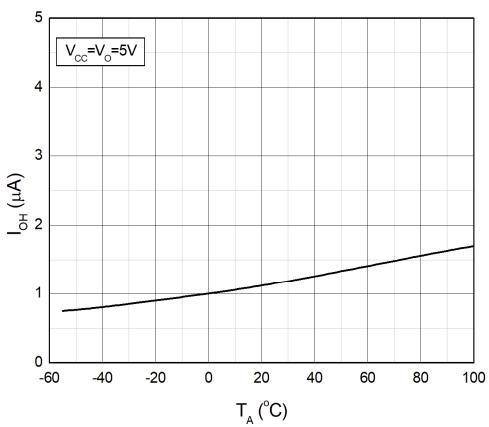
**Fig.7 Low Level Output Voltage  
vs. Ambient Temperature**



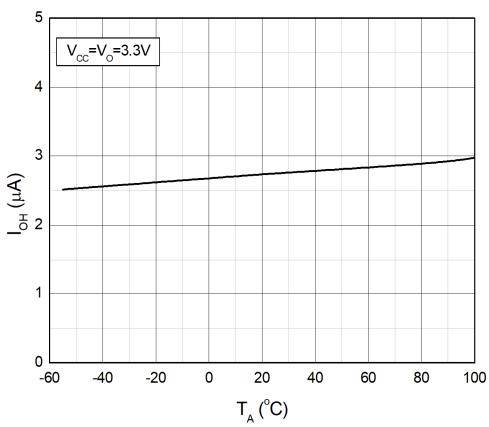
**Fig.8 Low Level Output Voltage  
vs. Ambient Temperature**



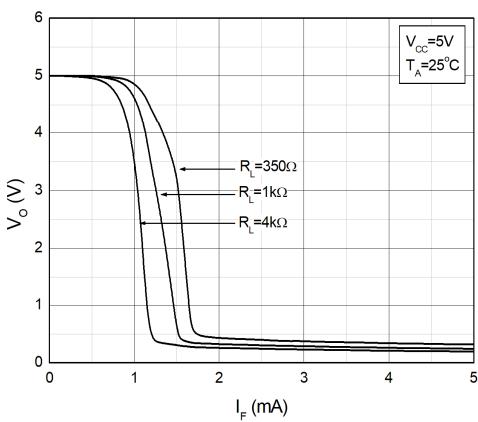
**Fig.9 High Level Output Current  
vs. Ambient Temperature**



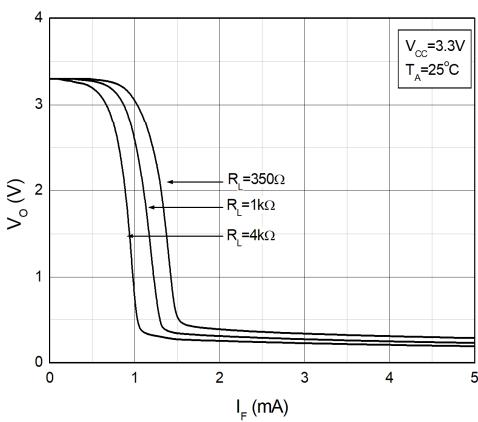
**Fig.10 High Level Output Current  
vs. Ambient Temperature**



**Fig.11 Output Voltage  
vs. Forward Current**



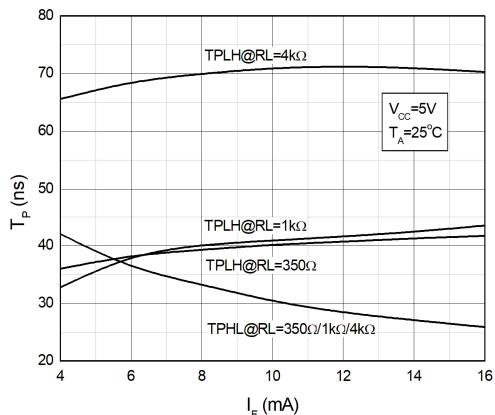
**Fig.12 Output Voltage  
vs. Forward Current**



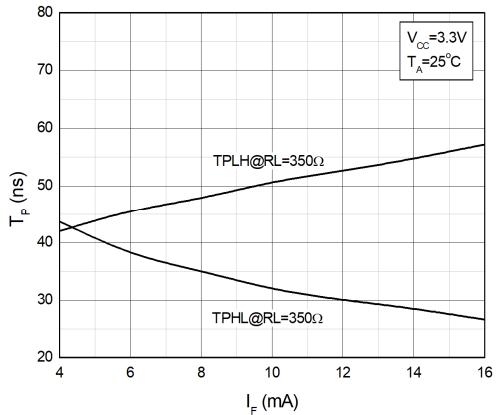


### CHARACTERISTIC CURVES

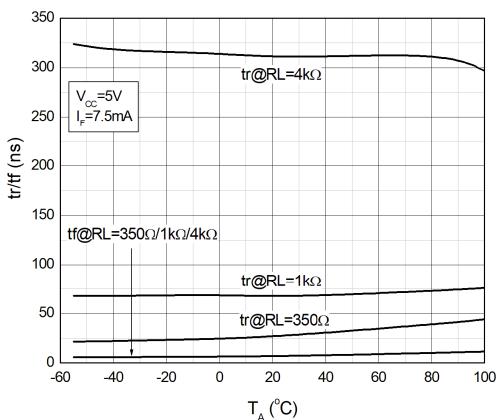
**Fig.13 Propagation Delay  
vs. Forward Current**



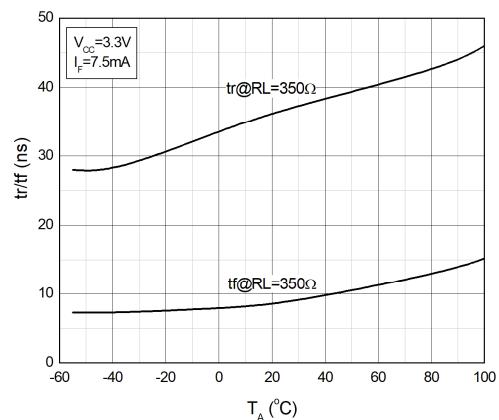
**Fig.14 Propagation Delay  
vs. Forward Current**



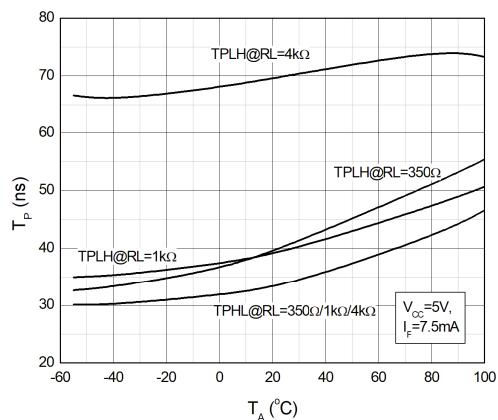
**Fig.15 Rise and Fall Time  
vs. Ambient Temperature**



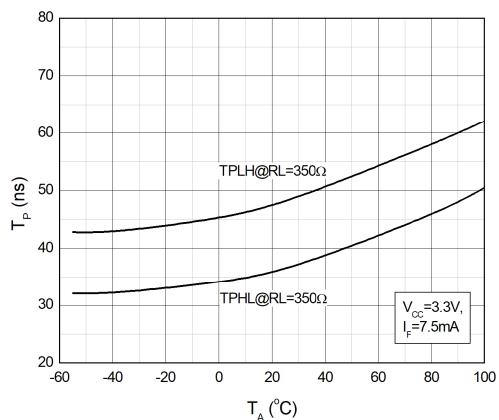
**Fig.16 Rise and Fall Time  
vs. Ambient Temperature**

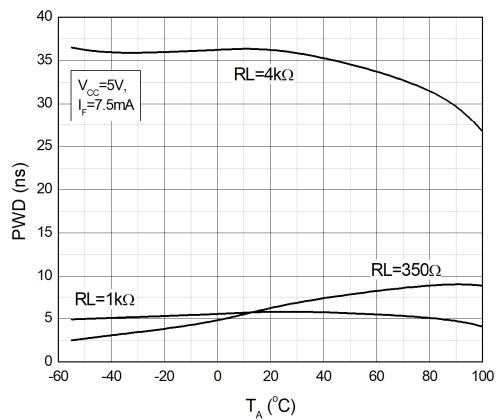
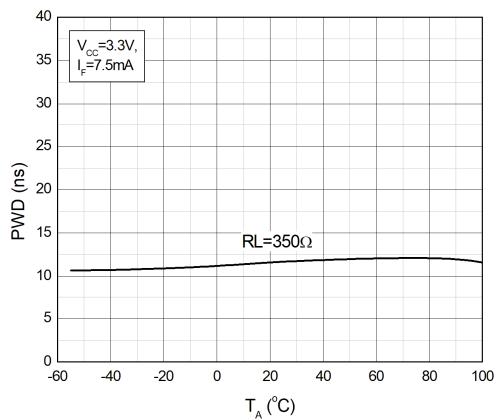
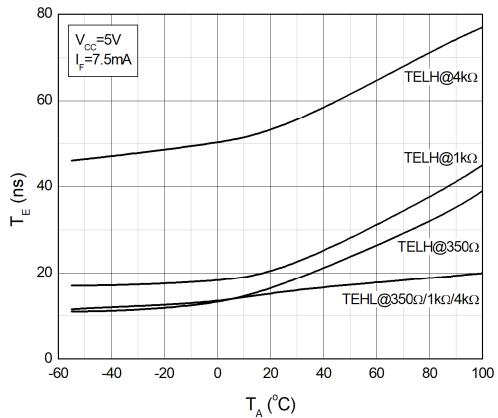
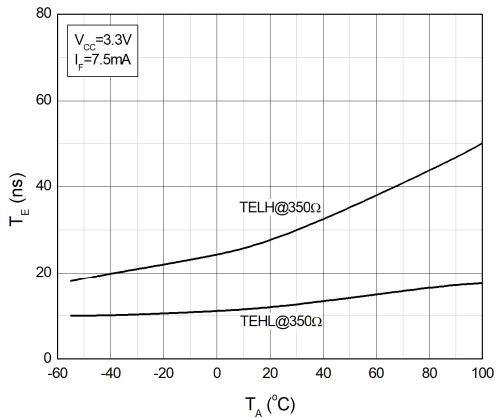


**Fig.17 Propagation Delay  
vs. Ambient Temperature**



**Fig.18 Propagation Delay  
vs. Ambient Temperature**



**CHARACTERISTIC CURVES****Fig.19 Pulse Width Distortion  
vs. Ambient Temperature****Fig.20 Pulse Width Distortion  
vs. Ambient Temperature****Fig.21 Enable Propagation Delay  
vs. Ambient Temperature****Fig.22 Enable Propagation Delay  
vs. Ambient Temperature**



## TEST CIRCUITS

Fig.23 Test Circuits for TPHL, TPLH, tr, tf

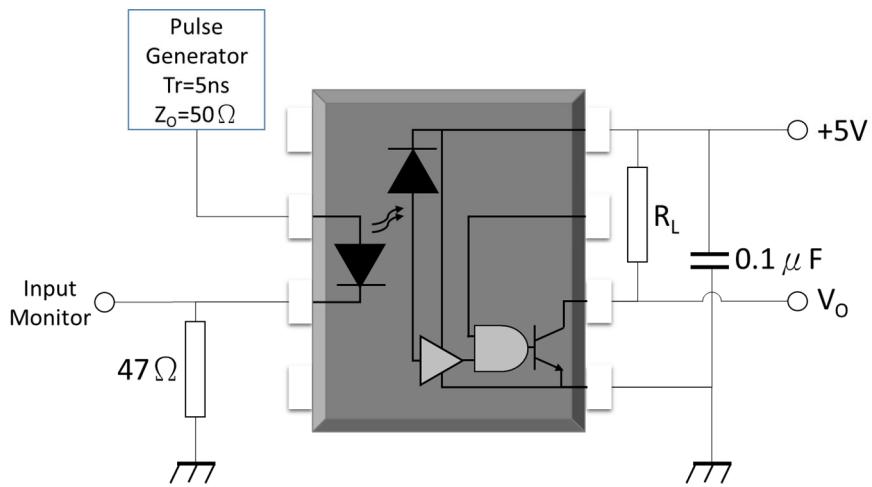
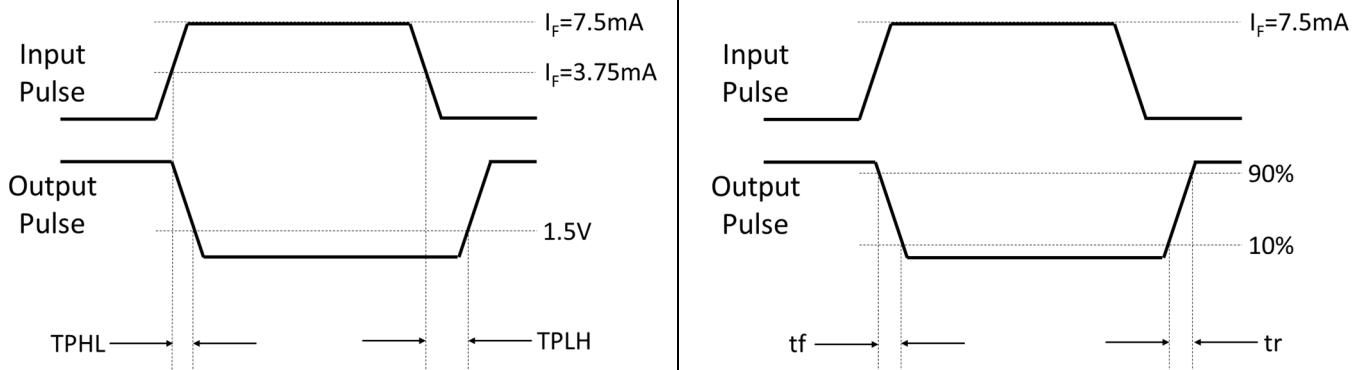


Fig.24 Waveforms of TPHL, TPLH, tr, tf





## TEST CIRCUITS

Fig.25 Test Circuits for TEHL, TELH

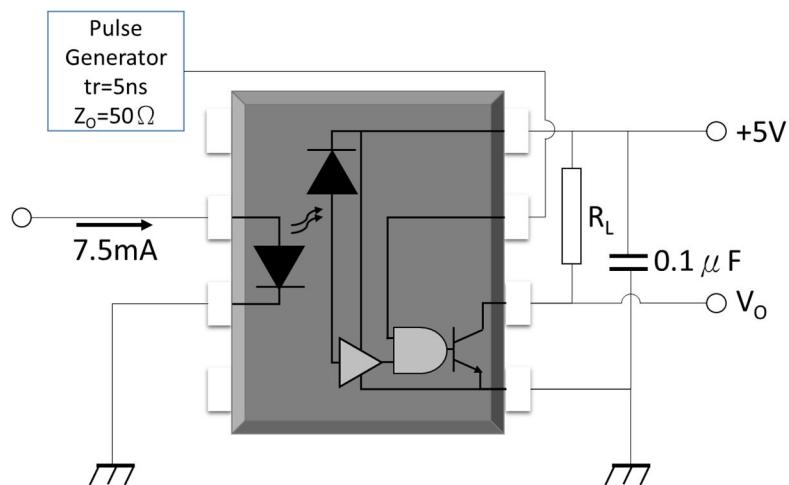
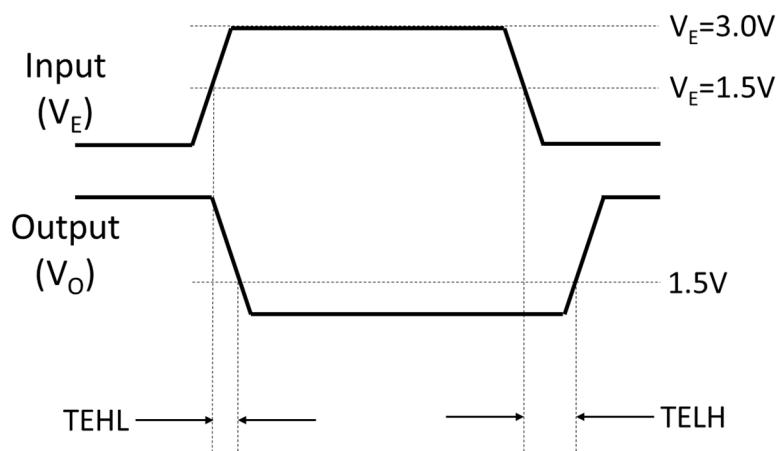


Fig.26 Waveforms of TEHL, TELH





## TEST CIRCUITS

Fig.25 Test Circuits for Common Mode Transient Immunity

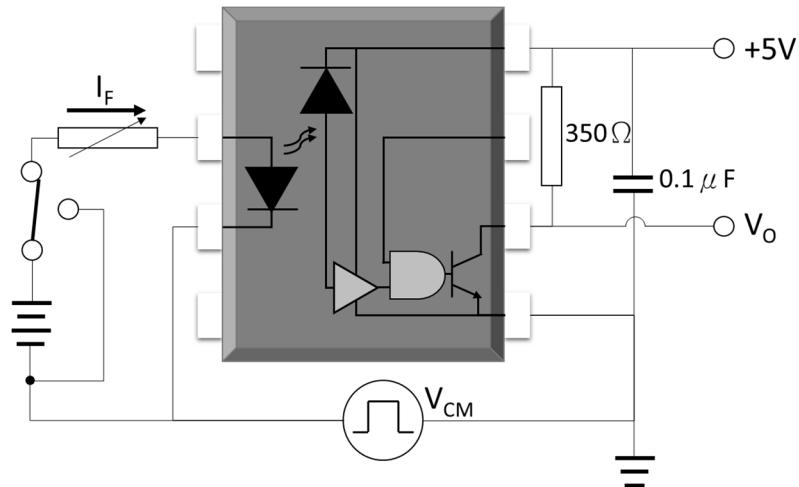
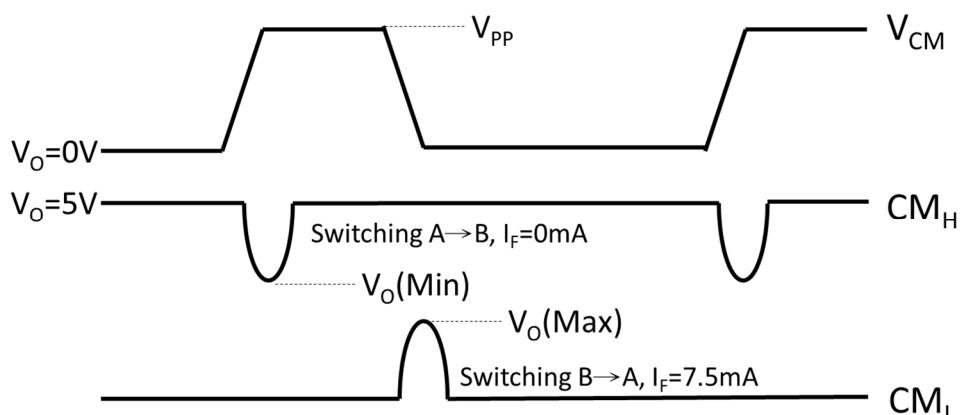


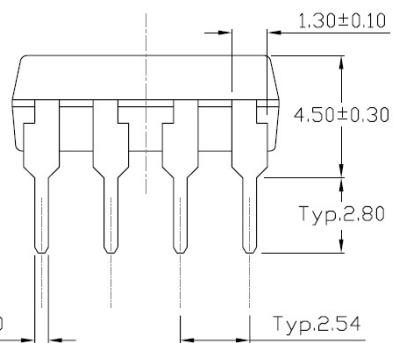
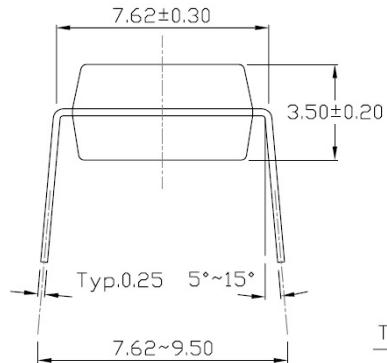
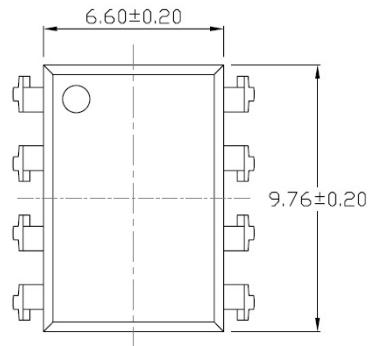
Fig.26 Waveforms of Common Mode Transient Immunity



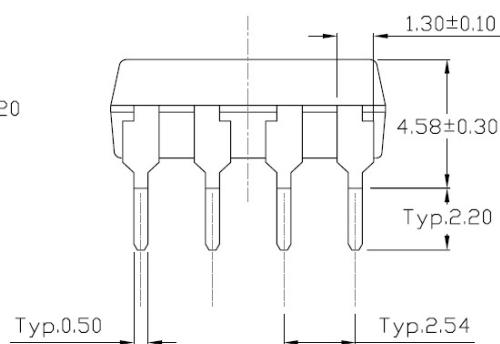
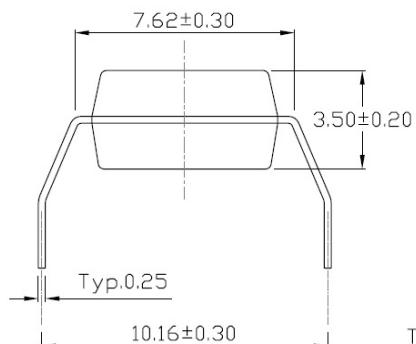
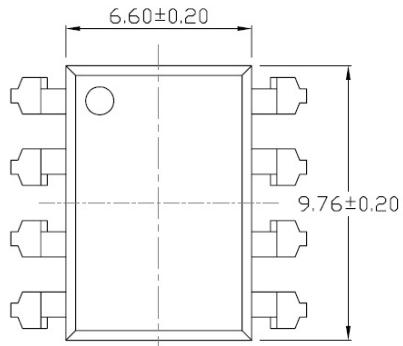


**PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**

**Standard DIP – Through Hole (DIP Type)**



**Gullwing (400mil) Lead Forming – Through Hole (M Type)**





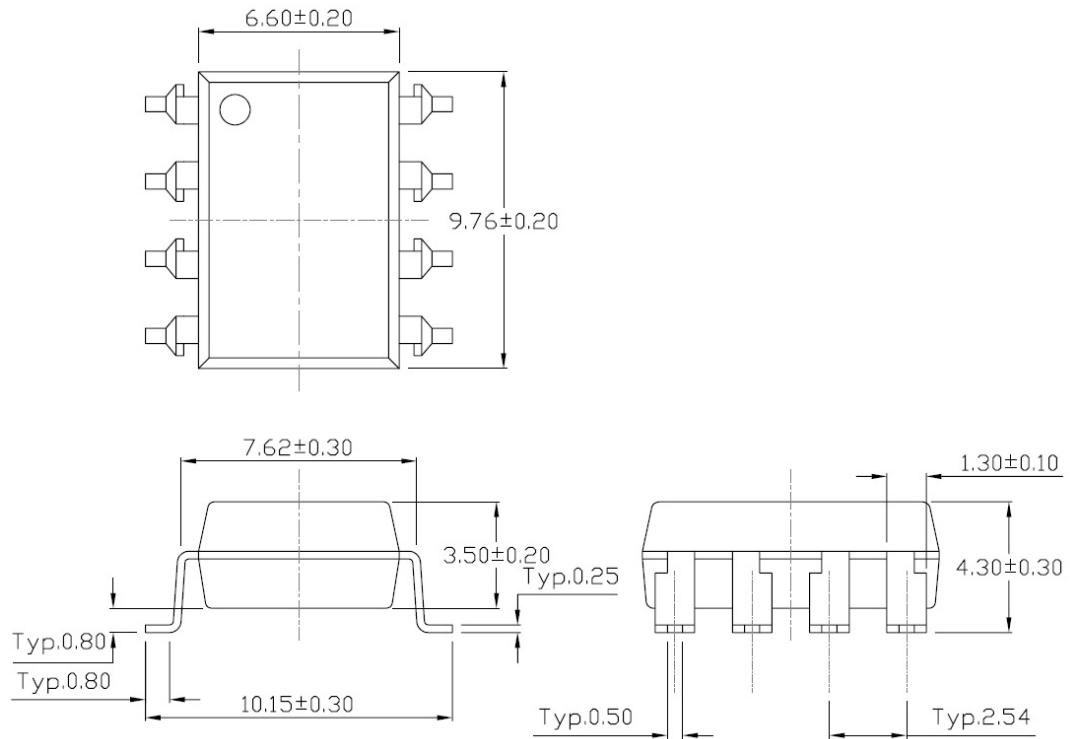
[www.tdled.com](http://www.tdled.com)

# **6N137,TD2601,TD2611 Series**

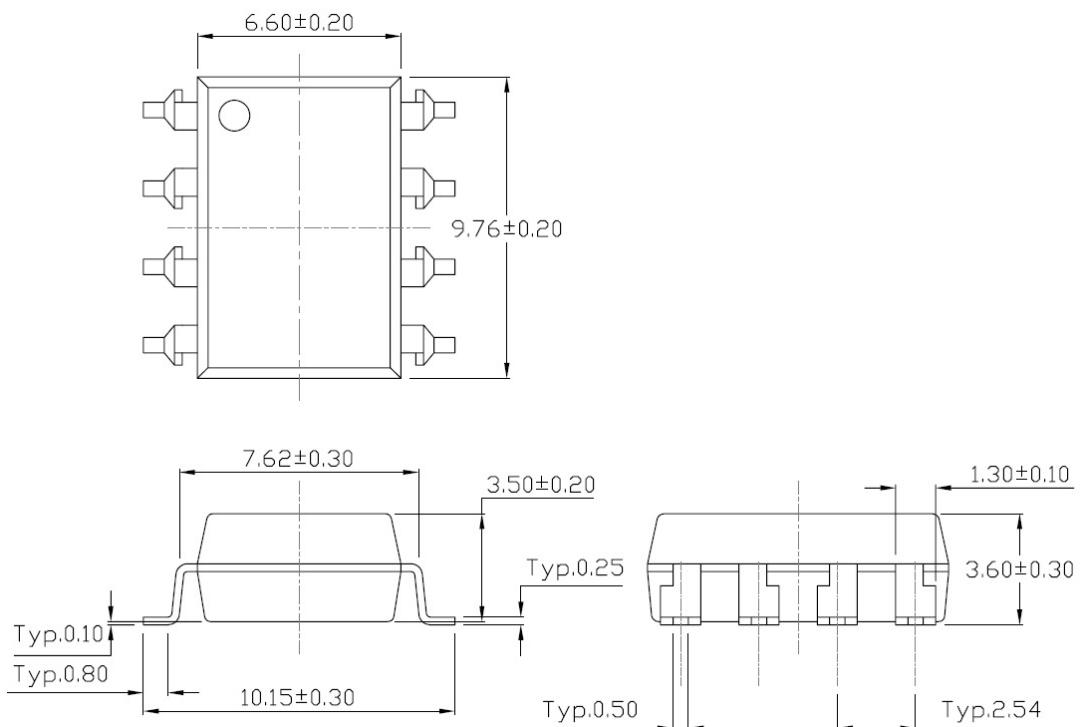
## **DIP8, 10Mbit/s High Speed Logic Gate Photo Coupler**

### **PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**

#### **Surface Mount Lead Forming (S Type)**



#### **Surface Mount (Low Profile) Lead Forming (SL Type)**





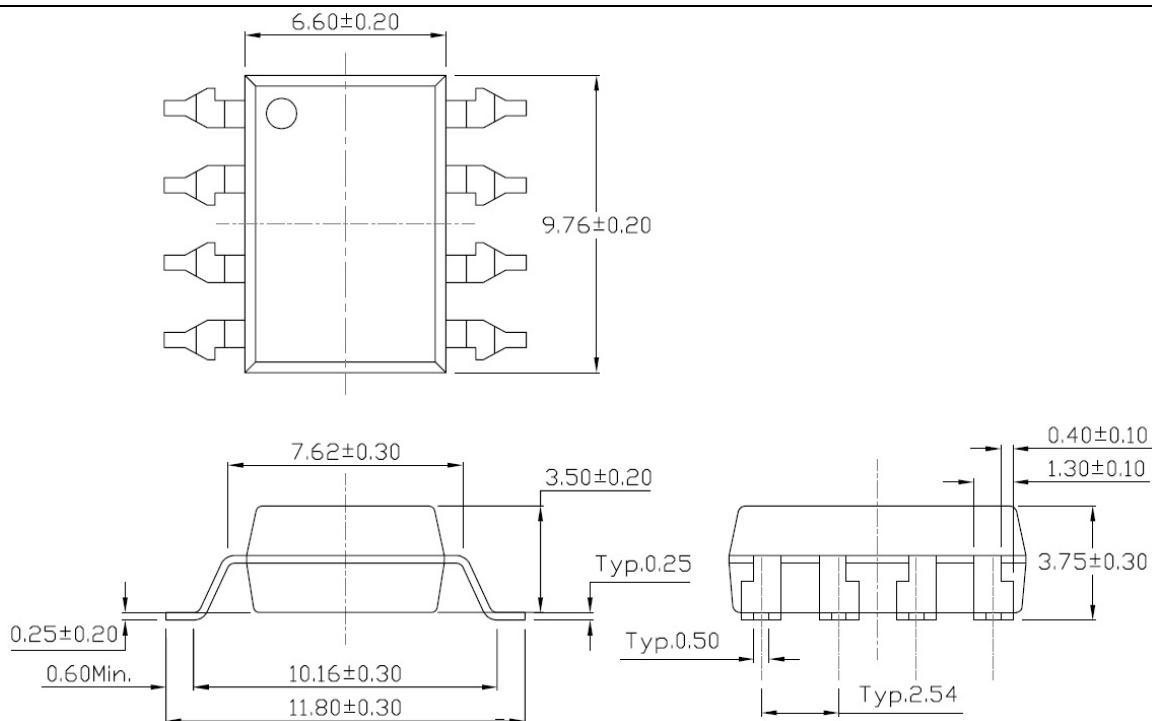
[www.tdled.com](http://www.tdled.com)

# 6N137,TD2601,TD2611 Series

## DIP8, 10Mbit/s High Speed Logic Gate Photo Coupler

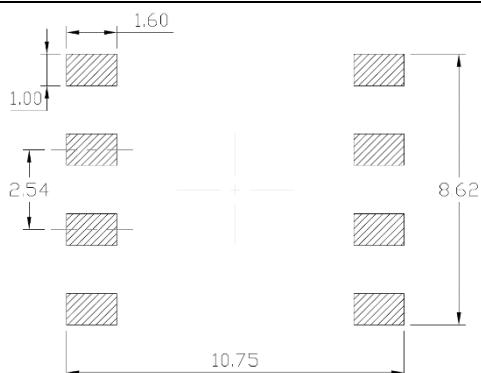
### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

#### Surface Mount (Gullwing) Lead Forming (SLM Type)

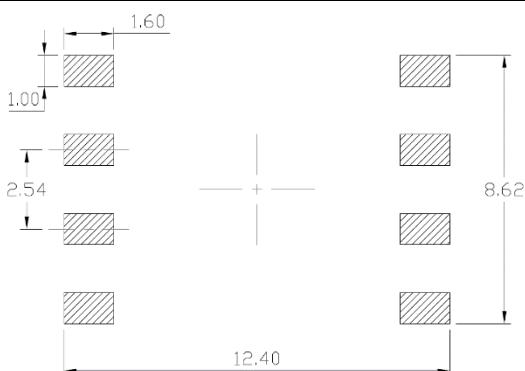


### Recommended Solder Mask (Dimensions in mm unless otherwise stated)

#### Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



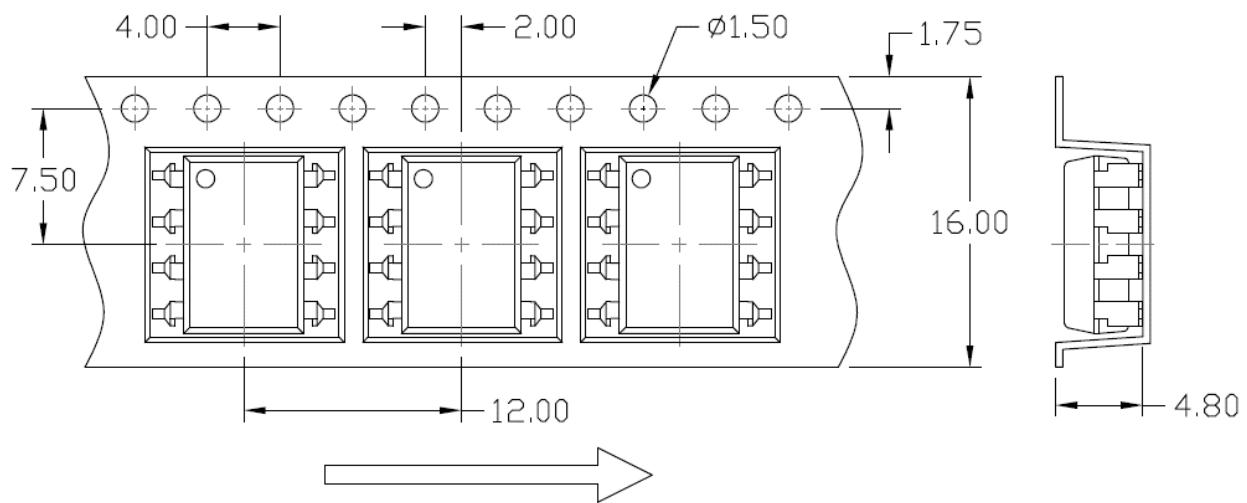
#### Surface Mount (Gullwing) Lead Forming



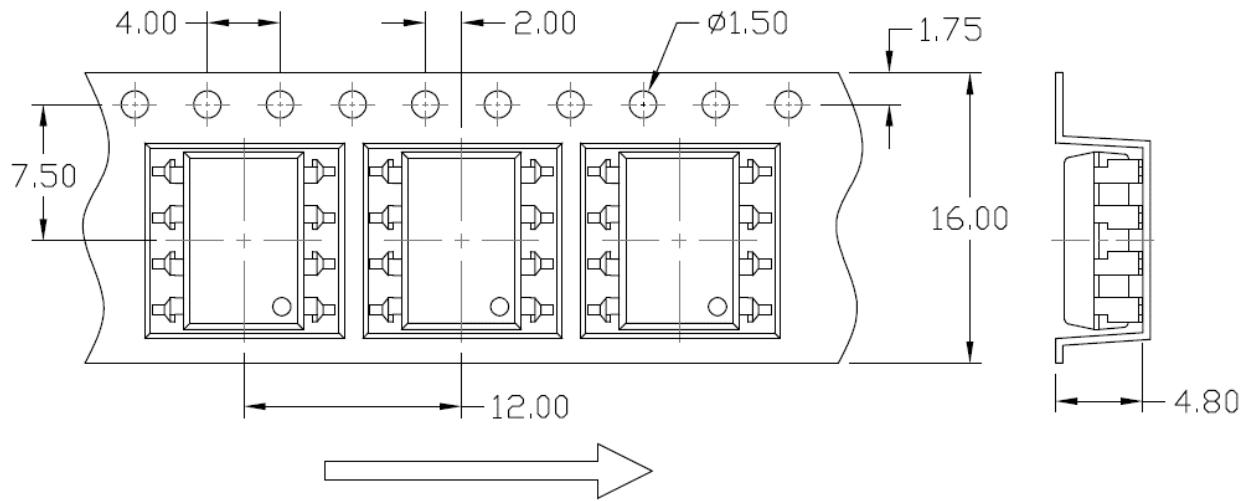


**Carrier Tape Specifications (Dimensions in mm unless otherwise stated)**

**Option S(T1) & SL(T1)**



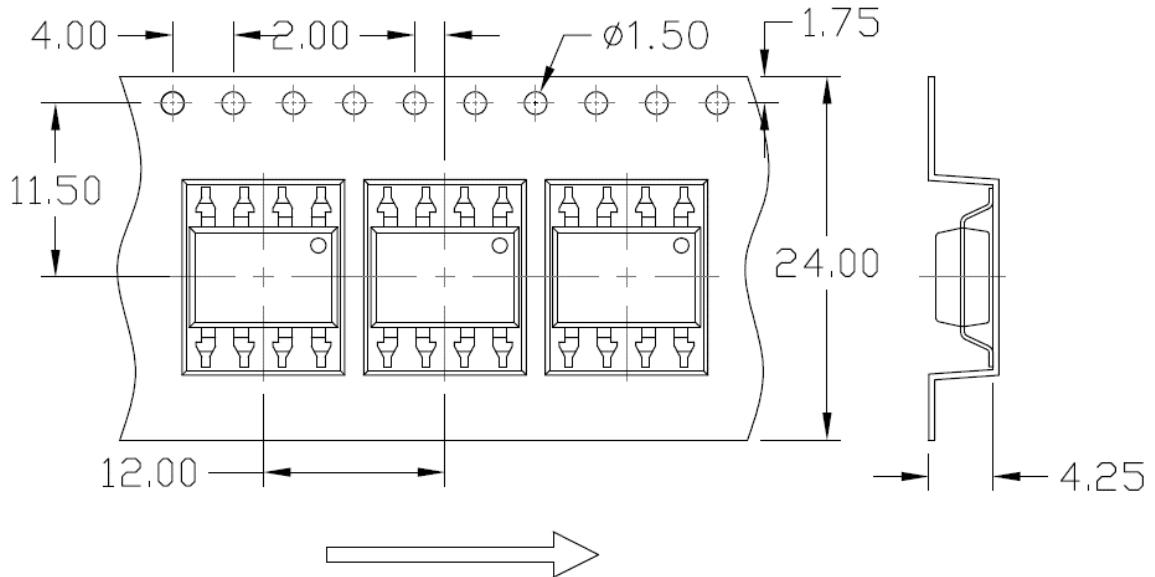
**Option S(T2) & SL(T2)**



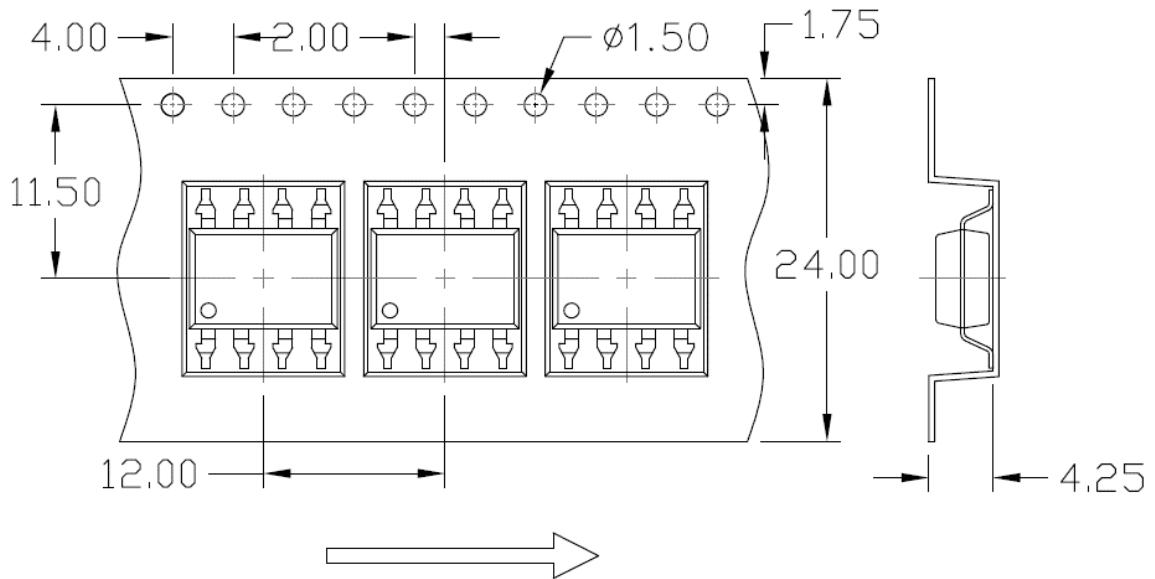


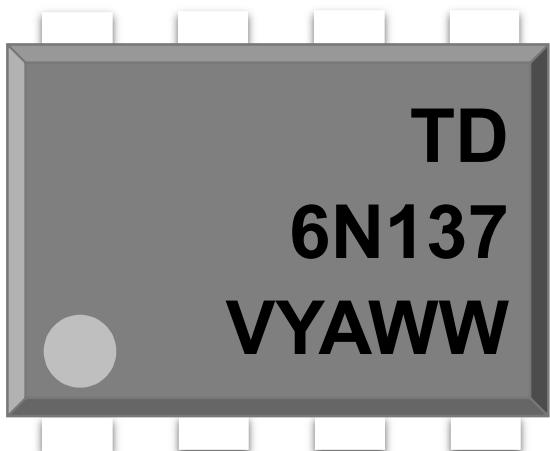
**Carrier Tape Specifications (Dimensions in mm unless otherwise stated)**

**Option SLM(T1)**



**Option SLM(T2)**



**ORDERING AND MARKING INFORMATION****MARKING INFORMATION**

TD : Company Abbr.  
6N137 : Part Number  
V : VDE Option  
Y : Fiscal Year  
A : Manufacturing Code  
WW : Work Week

**ORDERING INFORMATION****6N137(Y)(Z)-GV**

6N137 – Part Number

Y – Lead Form Option (M/S/SL/SLM/None)

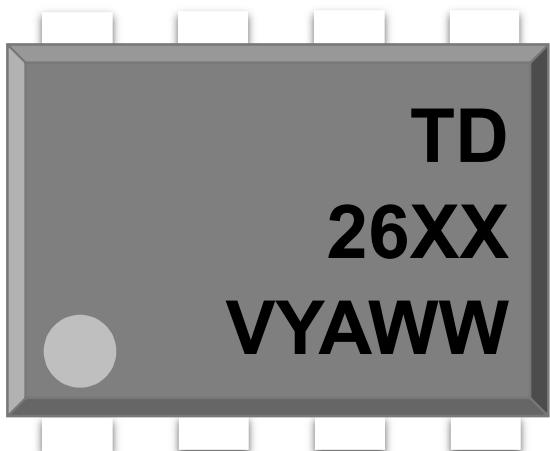
Z – Tape and Reel Option (T1/T2)

G – Material Option (G: Green, None: Non-Green)

V – VDE Option (V or None)

**PACKING QUANTITY**

| Option | Description  | Quantity        |
|--------|--|-----------------|
| None   | Standard 8 Pin Dip   | 50Units/Tube    |
| M      | Gullwing(400mil) Lead Forming                                  | 50Units/Tube    |
| S(T1)  | Surface Mount Lead Forming – With Option 1 Taping              | 1000 Units/Reel |
| S(T2)  | Surface Mount Lead Forming – With Option 2 Taping              | 1000 Units/Reel |
| SL(T1) | Surface Mount Lead Forming(Low Profile) – With Option 1 Taping | 1000 Units/Reel |
| SL(T2) | Surface Mount Lead Forming(Low Profile) – With Option 2 Taping | 1000 Units/Reel |

**ORDERING AND MARKING INFORMATION****MARKING INFORMATION**

TD : Company Abbr.  
26XX : Part Number & Rank  
V : VDE Option  
Y : Fiscal Year  
A : Manufacturing Code  
WW : Work Week

**ORDERING INFORMATION****TD26XX(Y)(Z)-GV**

TD – Company Abbr.

26XX – Rank (01/11)

Y – Lead Form Option (M/S/SL/SLM/None)

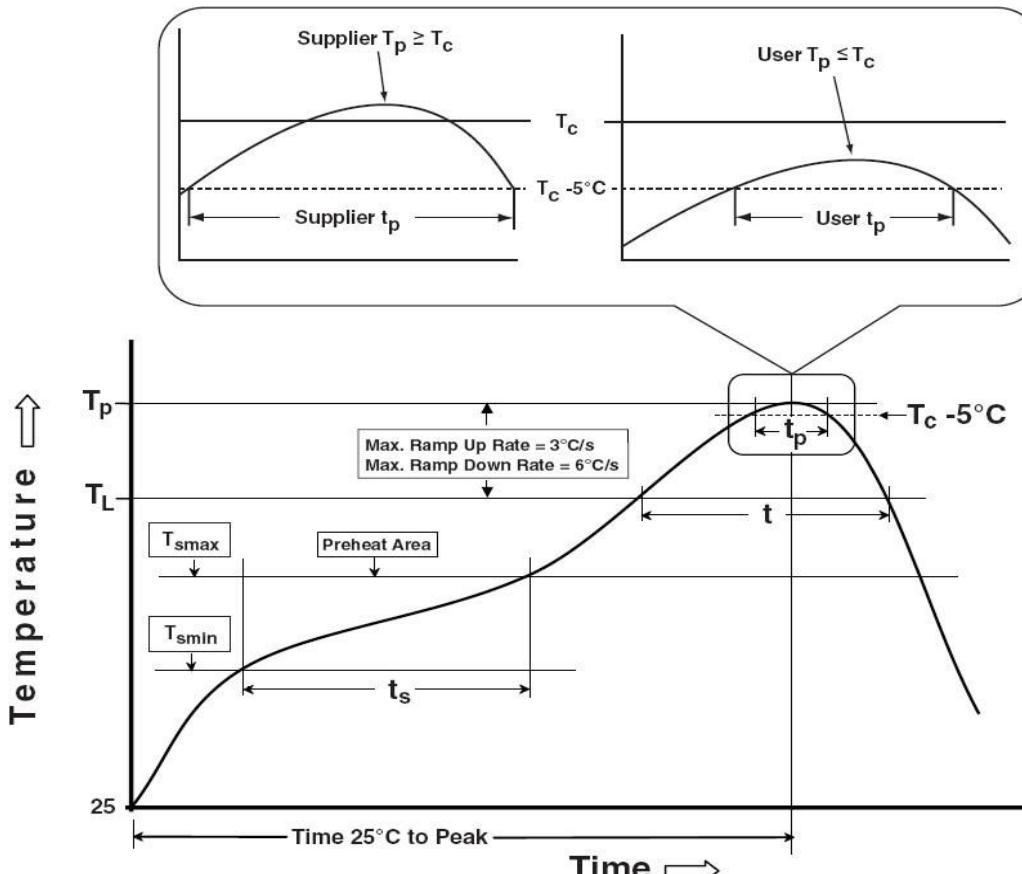
Z – Tape and Reel Option (T1/T2)

G – Material Option (G: Green, None: Non-Green)

V – VDE Option (V or None)

**PACKING QUANTITY**

| Option | Description  | Quantity        |
|--------|--|-----------------|
| None   | Standard 8 Pin Dip   | 50Units/Tube    |
| M      | Gullwing(400mil) Lead Forming                                  | 50Units/Tube    |
| S(T1)  | Surface Mount Lead Forming – With Option 1 Taping              | 1000 Units/Reel |
| S(T2)  | Surface Mount Lead Forming – With Option 2 Taping              | 1000 Units/Reel |
| SL(T1) | Surface Mount Lead Forming(Low Profile) – With Option 1 Taping | 1000 Units/Reel |
| SL(T2) | Surface Mount Lead Forming(Low Profile) – With Option 2 Taping | 1000 Units/Reel |

**REFLOW INFORMATION****REFLOW PROFILE**

| Profile Feature                             | Sn-Pb Assembly Profile | Pb-Free Assembly Profile |
|---|------------------------|--------------------------|
| Temperature Min. ( $T_{smin}$ )             | 100                    | 150°C                    |
| Temperature Max. ( $T_{smax}$ )             | 150                    | 200°C                    |
| Time ( $t_s$ ) from ( $T_{smin}$ to $T_L$ ) | 60-120 seconds         | 60-120 seconds           |
| Ramp-up Rate ( $t_L$ to $T_p$ )             | 3°C/second max.        | 3°C/second max.          |
| Liquidous Temperature ( $T_L$ )             | 183°C                  | 217°C                    |
| Time ( $t_L$ ) Maintained Above ( $T_L$ )   | 60 – 150 seconds       | 60 – 150 seconds         |
| Peak Body Package Temperature               | 235°C +0°C / -5°C      | 260°C +0°C / -5°C        |
| Time ( $t_p$ ) within 5°C of 260°C          | 20 seconds             | 30 seconds               |
| Ramp-down Rate ( $T_p$ to $T_L$ )           | 6°C/second max         | 6°C/second max           |
| Time 25°C to Peak Temperature               | 6 minutes max.         | 8 minutes max.           |



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- Please contact LIGHTNING sales agent for special application request.
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